

**PATENT APPLICATION**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Confirmation No.: 7113

Yuichi INADA, *et al.*

Art Unit: 1791

Application No.: 10/534,488

Examiner: Dimple N. BODAWALA

Filed: May 11, 2005

Attorney Dkt. No.: 059559.00020

For: MOLD FOR MOLDING, MOLDING METHOD, DISC SUBSTRATE, AND  
MOLDING MACHINE

**RESPONSE UNDER 37 C.F.R. §1.116**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450  
**MAIL STOP AF**

January 16, 2009

Sir:

In response to the Office Action dated September 19, 2008, having been duly extended from December 19, 2008, until January 19, 2009, by the attached Petition for Extension of Time, please amend the above-identified application as set forth below.

**Amendments to the claims are submitted beginning on page 2.**

**Remarks are submitted beginning on page 7.**